Technical Article **Reaping the Benefits of an MSP430™ MCU with Smart Analog Combo in Pulse Oximeter Designs**



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By measuring changes in infrared and red light absorption in oxygenated or deoxygenated blood, a pulse oximeter clipped to a finger noninvasively monitors a person's heart rate and blood oxygen saturation (SpO2). Normally, the oxygen saturation of a healthy person's blood is in the 95% to 100% range. Measuring oxygen saturation using a pulse oximeter like the one shown in Figure 1 can help patients:

- · See how well medicines are working
- Determine their ability to handle increased activity levels.
- Determine whether a ventilator is necessary or is working.
- Monitor episodes of sleep apnea.

People who have had health conditions that affect blood oxygen levels such as heart failure or asthma may also use a pulse oximeter.



Figure 1. Finger-clamp Pulse Oximeter

Usually, a photodiode measures the infrared and red light passing through the finger. The signal coming out of the photodiode sensor consists of a large DC component and a small AC component (AC is around 0.4% to 10% of DC), shown in Figure 2. The large DC component is a result of absorption by the lesser oxygen-bearing parts of body tissue and scattered light. The small AC component comprises light modulated by the oxygen-bearing parts, such as arteries, as well as noise from ambient light at 50/60 Hz. Both AC and DC components are necessary for SpO2 calculation. To meet the accuracy requirement, a signal conditioning circuit need to be designed to amplify the AC component with resolution increased, DC component and ambient light canceled. However, the signal level varies according to the health conditions of patients, and the position and thickness of the finger. The gain of amplifier need to be dynamically adjusted based on the range of signal to avoid signal saturation.

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Figure 2. Photoplethysmography Signal with Large DC and Small AC Component

TI has a single-chip pulse oximeter solution based on the MSP430FR2355 microcontroller (MCU) and its built-in smart analog combos (SACs). As a featured peripheral of the MSP430FR2355, the SACs are configurable with software and enable you to perform analog signal conditioning for either the input or output path. Figure 3 illustrates SAC mode.





Acting as the host MCU in the system, the MSP430FR2355 can provide a true single-chip solution that effectively removes the need for an external amplifier and digital-to-analog converter (DAC), reducing system



complexity and cost. Plus, you can configure each SAC module as an operational amplifier, programmable gain amplifier or 12-bit DAC. Figure 4 is a system block diagram of a pulse oximeter using an MSP430FR2355 MCU.



Figure 4. A Sample Pulse Oximeter System Block Diagram

The sample pulse oximeter solution in Figure 4 illustrates four SAC modules:

- Two SAC modules as a DAC with 12-bit resolution, for driving infrared and red LEDs with adjustable and stable current.
- One SAC module as a transimpedance amplifier, with 50 pA of input bias current for measuring photodiode current.
- One SAC module as a PGA, with 32 times gain working with the DAC used as DC compensation and an AC amplifier.

Besides built-in smart analog combos, the low to 42nA standby current, small package, memory configuration and communication interface is very suitable for a low-cost pulse oximeter design.

Figure 5 lists the detailed MSP430FR2355 MCU's on-chip analog and digital features.



5P430FR2	235X	Temperture	-40 ° C to 105	
MSP430FR2355				
Up to 24 MHz	Peripherals	Power	Power & Clocking	
	CRC16	PMM with	PMM with BOR, POR, PUC	
Memory	32 x 32 Multiplier		and 5V5	
Up to 32KB FRAM (with segment protection for code/data)	IR Modulation Logic			
	Interrupt Compare Control	oller FL		
Up to 4KB SRAM			REFO	
	Debug	М	ODOSC	
Analog	Embedded emulation		VLO	
x Comp with 6 - bit DAC	Real-time JTAG/SBW			
12 ch x 12- bit ADC	Bootstrap Loader	Con	Connectivity	
4 x SAC - L3		Up to	44 GPIOs	
(Configurable OA, PGA, 12 bit DAC combo)	Timers	Pa	ckages	
	Watchdog timer	4	8 LQFP	
Serial Interface	3 x 16 bit - TB w/ 3CC reg	js 40) VQFN	
	1 x 16 - bit TB w/ 700 reg	s 38	38 TSSOP	
2 x eUSCI_B (SPI/I ² C)	Real-time clock (Counter only)	32 (4mm x 4m	32 VQFN (4mm x 4mm, 0.4 mm pitch)	

Figure 5. MSP430FR2355 On-chip Features

Conclusion

The MSP430FR2355 is an ultra-low-power and low-cost 16-bit reduced instruction set computer MCU with many analog signal-chain peripherals. The four smart analog combs effectively remove the need for an external amplifier and digital-to-analog converter (DAC), reducing system complexity and cost. The low power and VQFN32 (4-mm-by-4-mm 32-pin) package is a good fit for a portable device such as a pulse oximeter. The MSP430 MCU along with the online software (https://www.ti.com/tool/MSPWARE) and hardware resources can help you design a pulse oximeter quickly.

Additional Resources

- Read the application reports, "MSP430's Analog Combo Enables True Single-Chip Pulse Oximeter Designs" and "How to Use the Smart Analog Combo in MSP430 MCUs."
- Read the technical article, "How to design an infrared thermometer quickly."

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